

Features

- 0606 0.4mm SMD LED
- High Brightness
- AlInGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-S66TFT5R5G5B is a tri-color 0606, 6pin package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

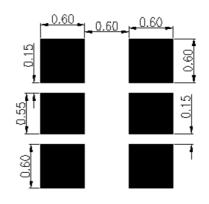
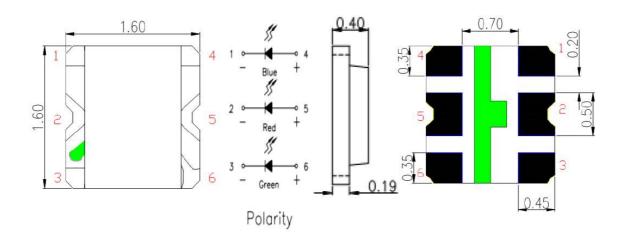


Figure 1. IN-S66TFT5R5G5B Solder Pattern

Package Dimensions in mm



Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.10 mm unless otherwise noted

Figure 2. IN-S66TFT5R5G5B Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	T _{OP} (°C)	T _{st} (°C)
	Red 60			70			
IN-S66TFT5R5G5B	Green	90	25	100	5	-30°C~+85°C	-40ºC~+90ºC
	Blue	90		100			

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics $T_A = 25$ °C (Note 1)

Product	Emission		V _F (V)		λ(nm)			Viewing Angle	l* _v (mcd)
	Color	l _F (mA)	typ.	max	λ_{D}	λ_{P}	$ riangle \lambda$	2 <i>0</i> 1/2	typ.
	Red	5	2.0	2.4	620	630	20	120	45
IN-S66TFT5R5G5B	Green	5	2.8	3.1	525	524	35	120	285
	Blue	5	2.8	3.1	470	464	30	120	56

Notes

1. Performance guaranteed only under conditions listed in above tables.



Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range				
	H1	28.5-35.0 mcd				
Red	H2	35.0-45.0 mcd				
Reu	J1	45.0-56.0 mcd				
	J2	56.0-72.0 mcd				
	M2	230.0-285.0 mcd				
Green	N1	285.0-350.0 mcd				
	N2	350.0-400.0 mcd				
	H2	35.0-45.0 mcd				
Dhuo	J1	45.0-56.0 mcd				
Blue	J2	56.0-72.0 mcd				
	K1	72.0-90.0 mcd				

@5mA / Ta=25° C, Tolerance: ± 10%

Dominant Wavelength (λD) Bin:

• • • •							
Color	Bin Code	Spec. Range					
	A	615-620					
Red	В	620-625					
	С	625-630					
	D	521-524					
Green	E	524-527					
	F	527-530					
	В	461-464					
Blue	С	464-467					
Diue	D	467-470					
	E	470-473					

@5mA / Ta=25° C, Tolerance: ± 0.5nm

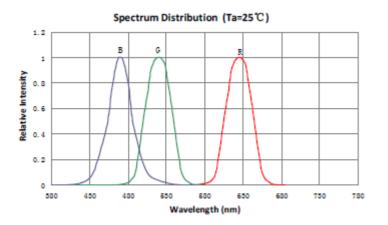
Bin Code Color Spec. Range 1.8-2.0 1 Red 2 2.0-2.2 5 2.5-2.7 6 2.7-2.9 Green 7 2.9-3.1 5 2.5-2.7 6 2.7-2.9 Blue 7 2.9-3.1

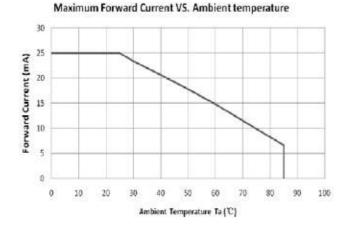
Forward Voltage (Vf) Bin:

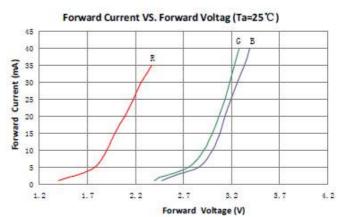
@5mA / Ta=25° C, Tolerance: ± 0.05V

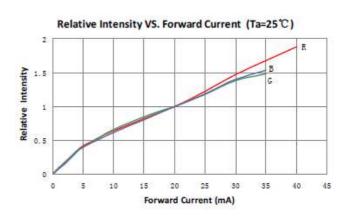


Typical Characteristic Curves

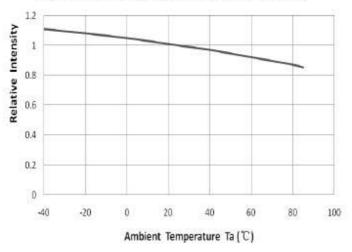






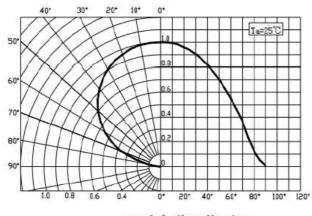








Typical Characteristic Curves – Radiation Pattern



spatial distribution

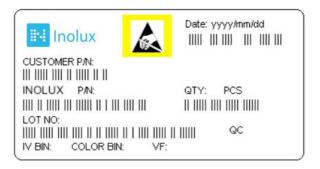
Ordering Information

Product	Emission Color	Test Current I⊧ (mA)	Luminous Intensity Iv (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number	
	Red	5	45	2.0		
IN-S66TFT5R5G5B	Green 5		285	2.8	IN-S66TFT5R5G5B	
	Blue	5	56	2.8		

Bin Range specified on page 3.



Label Specifications



Inolux P/N:

I	Ν	-	S	6	6	т	F	Т	5	R	5	G	5	В	-	
			Material	Pac	kage	Varia	ation	Orientation	Current	Color	Current	Color	Current	Color		Customized Stamp-off
	nolux SMD		S = PCB Type	1.		ΓF = x 0.4m	m	T = Top Mount	5= 5mA	R= 622nm	5= 5mA	G= 527nm	5= 5mA	B= 470nm		

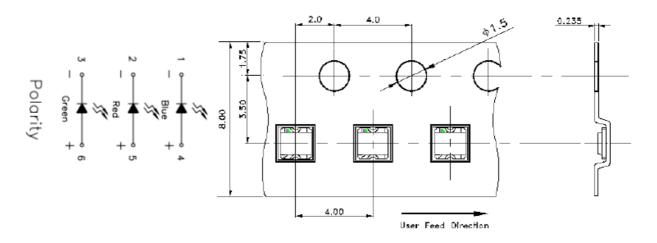
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	. 2018)	Month	Date	Serial	
Tracker			,, ,				

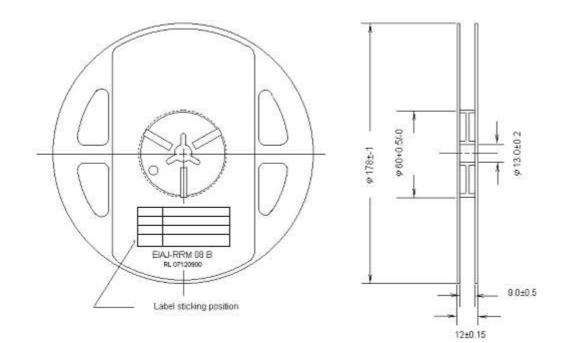


Packaging Information: 4000pcs Per Reel

Tape Dimension

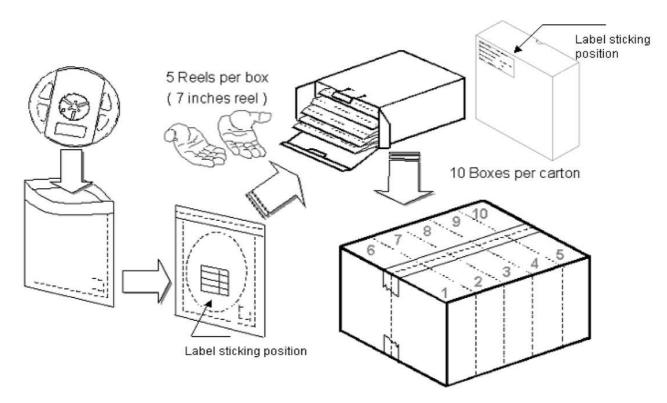


Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

Specification	Material	Quantity
Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Per EIA 481-1A specs	Conductive black	
IN standard	Paper	
220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
IN standard	Paper	Non-specified
	Per EIA 481-1A specs Per EIA 481-1A specs IN standard 220x240mm	Per EIA 481-1A specsConductive black tapePer EIA 481-1A specsConductive blackIN standardPaper220x240mmAluminum laminated bag/ no-zipper

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

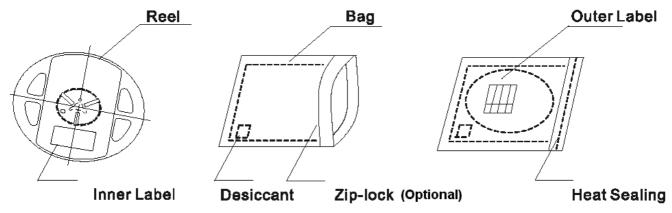


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

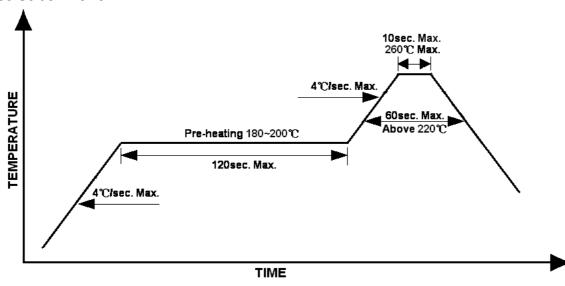
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



Reliability

ltem	Frequency/ lots/ samples/	Standards	Conditions
nem	failures	Reference	
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according		2.) Moisture storage at 85°C/ 60% R.H. for
	to JEDEC Level 2		168hrs
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s
			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
		CNS-5067	Dipping soldering terminal only
Resistance to			Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s
			B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test			85°C/ 60%R.H. for 168hrs
			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature			Humidity: 85% R.H., IF=5mA
bias	10/1/00	IN 1	Duration: 1000hrs
High temperature	1Q/ 1/ 20	IN specs.	Tamb: 55°C
bias			IF=20mA Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test	10/1/40/0		cycle=0.125 (tp=125 μ s,T=1sec)
ruise ille lest			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
	TQ/ 1/ 76/ 0	IEC 68-2-14, Nb	15min
Temperature		1EC 00-2-14, ND	Thermal steady within 5 min
cycle			300 cycles
			2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C
storage test			90+5/-10% R.H. for 500hrs
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test			
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test			
		1	

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Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	03-20-2020

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